

Size $6.0 \times 6.0 \times 3.0$ (mm)

Series/Type: B82462A4

Date: October 2019

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Size 6.0 x 6.0 x 3.0 (mm)

B82462A4

<u>SMD</u>

Rated inductance 1 ... 1000 µH Rated current 0.11 ... 3 A

Construction

- Ferrite core
- Winding: enamel copper wire
- Winding welded to terminals

Features

- Temperature range up to +150 °C
- High rated current
- Low DC resistance
- Suitable for lead-free reflow soldering as referenced in JEDEC J-STD 020D
- Qualified to AEC-Q200
- RoHS-compatible

Applications

- Filtering of supply voltages
- Coupling, decoupling
- DC/DC converters
- Automotive electronics
- Industrial electronics

Terminals

- Base material CuSn6
- Layer composition Ag, Sn (lead-free)¹⁾
- Electro-plated

Marking

- Marking on component:
 Manufacturer, L value (nH, coded),
 L tolerance (coded), manufacturing date (YWWD)
- Minimum data on reel: Manufacturer, ordering code, L value,
- quantity, date of packing

Delivery mode and packing unit

- 12-mm blister tape, wound on 330-mm Ø reel
- Packing unit: 2500 pcs./reel
- 1) Ni-barrier-plated terminals on request (B82462A4*50).



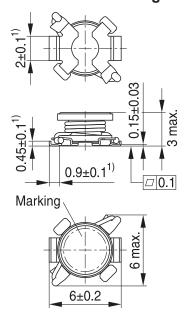


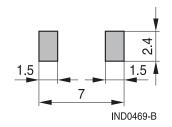
B82462A4

Size 6.0 x 6.0 x 3.0 (mm)

SMD

Dimensional drawing and layout recommendation





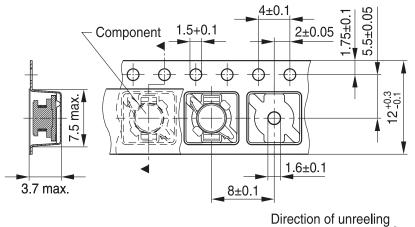
1) Soldering area

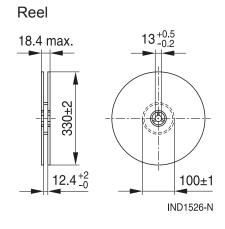
IND0471-F-E

Dimensions in mm

Taping and packing

Blister tape





IND1543-4-E

Dimensions in mm



SMT power inductors	B82462A4
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Size 6.0 x 6.0 x 3.0 (mm)

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Technical data and measuring conditions

Rated inductance L _R	Measured with impedance analyzer Agilent 4294A or equivalent at frequency f_L , 0.1 V, +20 $^{\circ}$ C				
Operating temperature range	−55 + 150 °C				
Rated current I _{temp, typ}	Max. permissible DC with temperature increase of \leq 40 K at +85 °C				
Saturation current I _{sat}	Max. permissible DC with inductance decrease $\Delta L/L_0$ of approx. 10%				
DC resistance R _{max}	Measured at +20 °C				
Solderability (lead-free)	Dip and look method Sn95.5Ag3.8Cu0.7: $+(245\pm5)$ °C, (5 ± 0.3) s Wetting of soldering area $\geq 90\%$ (based on IEC 60068-2-58)				
Resistance to soldering heat	+260 °C, 40 s as referenced in JEDEC J-STD 020D				
Climatic category	55/150/56 (to IEC 60068-1)				
Storage conditions	Mounted: -55 °C +150 °C Packaged: -25 °C +40 °C, ≤75% RH				
Weight	Approx. 0.2 g				



Size 6.0 x 6.0 x 3.0 (mm)

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Characteristics and ordering codes

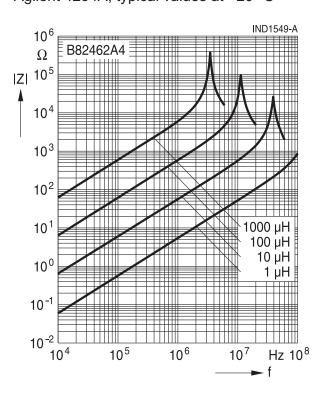
L _R μΗ	Tolerance	f _L MHz	I _{sat,typ}	I _{sat,min}	I _{temp,typ}	R_{max} Ω	R_{typ} Ω	Ordering code ¹⁾
1.0	±20% ≙ M	0.1	6.80	5.8	3.00	0.024	0.018	B82462A4102M000
1.5		0.1	5.50	4.6	2.60	0.030	0.024	B82462A4152M000
2.2		0.1	4.40	3.8	2.30	0.042	0.033	B82462A4222M000
3.3		0.1	3.25	3.2	2.00	0.06	0.047	B82462A4332M000
4.7		0.1	3.20	2.8	1.65	0.08	0.055	B82462A4472M000
6.8		0.1	2.65	2.3	1.40	0.10	0.081	B82462A4682M000
10		0.1	2.08	1.8	1.15	0.14	0.113	B82462A4103M000
15	±10% ≙ K	0.1	1.72	1.5	0.90	0.21	0.185	B82462A4153K000
22		0.1	1.32	1.28	0.80	0.26	0.24	B82462A4223K000
33		0.1	1.12	1.04	0.63	0.42	0.34	B82462A4333K000
47		0.1	0.93	0.82	0.54	0.64	0.52	B82462A4473K000
68		0.1	0.84	0.69	0.43	0.86	0.75	B82462A4683K000
100		0.1	0.67	0.57	0.35	1.28	1.15	B82462A4104K000
150		0.1	0.57	0.49	0.29	1.76	1.67	B82462A4154K000
220		0.1	0.46	0.40	0.24	2.72	2.3	B82462A4224K000
330		0.1	0.36	0.34	0.20	3.9	3.5	B82462A4334K000
470		0.1	0.33	0.28	0.17	5.6	5.1	B82462A4474K000
680		0.1	0.24	0.23	0.14	8.0	7.3	B82462A4684K000
1000		0.1	0.19	0.18	0.11	13.0	11.4	B82462A4105K000

¹⁾ For Ni-barrier-plated terminals replace the last two digits "00" by "50".

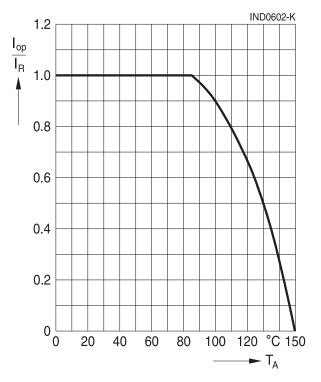


Size 6.0 x 6.0 x 3.0 (mm)

Impedance |Z| versus frequency f measured with impedance analyzer Agilent 4294A, typical values at +20 °C

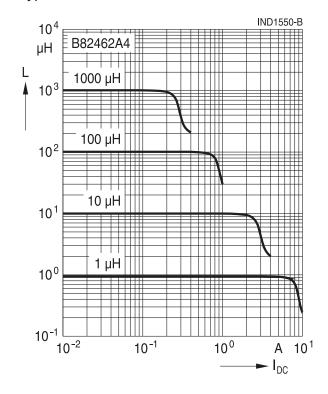


Current derating I_{op}/I_R versus ambient temperature T_A (rated temperature $T_R = +85$ °C)



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Inductance L versus DC load current I_{DC} measured with LCR meter Agilent 4285A, typical values at +20 °C





Cautions and warnings

- Please note the recommendations in our Inductors data book (latest edition) and in the data sheets.
 - Particular attention should be paid to the derating curves given there.
 - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.
 Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g. ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.
- The following points must be observed if the components are potted in customer applications:
 - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
 - It is necessary to check whether the potting material used attacks or destroys the wire, wire insulation, plastics or glue.
 - The effect of the potting material can change the high-frequency behaviour of the components.
 - Many coating materials have a negative effect (chemically and mechanically) on the winding wires, insulation materials and connecting points. Customers are always obligated to determine whether and to what extent their coating materials influence the component. Customers are responsible and bear all risk for the use of the coating material. TDK Electronics does not assume any liability for failures of our components that are caused by the coating material.
- Ceramics / ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.

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Release 2018-10

Mouser Electronics

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B82462A4223K B82462A4224K B82462A4332M B82462A4333K B82462A4334K B82462A4472M B82462A4473K

B82462A4474K B82462A4682M B82462A4683K B82462A4684K B82462A4154K B82462A4152M



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